



Precautions When Mounting on a Printed Circuit Board

1. Please open and close (Push-Open) the socket only after it is securely mounted on the board. Opening and closing the socket before mounting may apply an unintended load on the terminal fixing area, potentially leading to loosening or damage to the terminals.
2. Handle with care to avoid applying any shock or load to the terminals until the socket is soldered onto the printed circuit board. When using a soldering iron, ensure that no load is placed on the terminals during the soldering process, as this can cause deformation or loosening of the terminals, which may reduce contact performance.
3. Solder the socket so there is no gap between the printed circuit board's mounting surface and the bottom of the socket. If the socket is soldered while floating above the board, terminals may detach or result in poor contact, compromising performance.

Date	JC ELECTRONICS CORPORATION	
2025/05/27		
Materials Finish	SPRING: Stainless steel CONTACT: Copper Alloy, Au plating over Ni INSULATOR BODY: PES	
Dimensions Style	Title	Test Socket For Crystal Device
mm /inch	Part Number	GUT8-6-3225T09-P12
Third Angle Projection		
Rev.No	0	